

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re Patent Application of )  
Man WONG et al ) Group Art Unit: Unassigned  
Application No.: Unassigned ) Examiner: Unassigned  
Filed: December 3, 2003 ) Confirmation No.: Unassigned  
For: AN INTEGRATED ELECTRONIC )  
MICROPHONE (AS AMENDED) )  
 )  
 )  
)

**FIRST INFORMATION DISCLOSURE STATEMENT**

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

In accordance with the duty of disclosure as set forth in 37 C.F.R. § 1.56, applicants hereby identify the following information in conformance with 37 C.F.R. §§ 1.97 and 1.98.

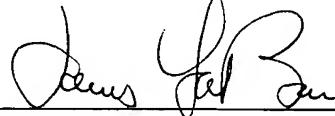
All of the listed documents were previously made of record by applicants or by the Examiner in prior Application No. 10/050,858, filed January 18, 2002, upon which applicants rely for the benefits provided in 35 U.S.C. § 120, and therefore copies of the documents have not been provided pursuant to the provisions of 37 C.F.R. §1.98(d).

To assist the Examiner, the documents are listed on the attached form PTO-1449. It is respectfully requested that an Examiner initialed copy of this form be returned to the undersigned.

Respectfully submitted,

BURNS, DOANE, SWECKER & MATHIS, L.L.P.

Date December 3, 2003

By:   
James A. LaBarre  
Registration No. 28,632

P.O. Box 1404  
Alexandria, Virginia 22313-1404  
(703) 836-6620

**FIRST  
INFORMATION DISCLOSURE  
STATEMENT BY APPLICANT**

(use as many sheets as necessary)

Sheet 1 of 1

<i>Complete if Known</i>	
<b>Application Number</b>	Unassigned
<b>Filing Date</b>	December 3, 2003
<b>First Named Inventor</b>	Man WONG et al
<b>Examiner Name</b>	Unassigned
<b>Attorney Docket Number</b>	016660-188

## U.S. PATENT DOCUMENTS

## FOREIGN PATENT DOCUMENTS

## NON-PATENT LITERATURE DOCUMENTS

Examiner Initials	Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.), date, page(s), volume-issue number(s), publisher, city and/or country where published.
	Bergqvist, J., et al., "Capacitive Microphone with a Surface Micromachined Backplate Using Electroplating Technology", <i>Journal of Microelectromechanical Systems</i> , Vol. 3, No. 2, June 1994, pp. 69-75, IEEE (1994).
	Zou, Q.B., et al, "Design and Fabrication of a Novel Integrated Floating-Electrode-'Electret'-Microphone (FEEM)", <i>Proceedings of the 11th International Workshop on Micro Electro Mechanical Systems</i> , January 1998, pp. 586-590, IEEE (1998).
	Murphy, P., et al, "Subminiature Silicon Integrated Electret Condenser Microphone", <i>6th International Symposium on Electrets (ISE 6) Proceedings</i> , 1988, abstract.